

Abstract Submitted  
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**Relating Organic Solar Cell Fabrication Methods to Internal Electronic Properties Using Impedance Spectroscopy** JAMES BASHAM, The Pennsylvania State University, National Institute of Standards and Technology, DAVID GUNDLACH, National Institute of Standards and Technology, THOMAS JACKSON, The Pennsylvania State University — We report on the use of impedance spectroscopy to quantify the effect of processing on an array of important OPV device metrics. Interestingly, extract modeled mobilities over the range of  $2 \times 10^{-3}$  to  $1 \times 10^{-2}$   $\text{cm}^2/\text{Vs}$  by changing the spinning recipe. We find fast carrier relaxation times of  $1 \times 10^{-4}$  s for 3% efficiency cells vs  $3 \times 10^{-6}$  s for a 1.8% efficiency cell, possibly demonstrating reduced recombination in more efficient devices. Devices made via slowly dried films exhibit repressed recombination compared to quickly dried films. Measurements are taken across a bias range of -1 to 1 volt with illumination intensities spanning .001 to 3 suns, in order to test under conditions which are most relevant to real device operation. Impedance spectra are analyzed through the use of a 5 element compact model based upon the work of Bisquert et al [1,2]. We report an array of device metrics measured via impedance spectroscopy including shunt resistance, effective carrier lifetime, mobility, and capacitance for P3HT:PCBM devices with efficiencies of 3.5% to <1%, fabricated via several common recipes, in an effort to elucidate the varied and complex interplay between processing and device physics, and the overall effect on solar cell efficiency. [1] Fabregat-Santaigo, F., Garcia-Belmonte, G., Mora-Sero, I., and Bisquert, J. Phys. Chem. Chem. Phys., 2011, 13, 9083–9118 [2] Garcia-Belmonte, G., Boix, P.P., Bisquert, J., Sessolo, M., and Bolink, H.J. Solar Energy Materials & Solar Cells 94(2010)366–375

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